



HENKEL SOLUTIONS FOR AUTOMOTIVE ELECTRONICS COMPONENTS

BERGQUIST® GAP FILLER TGF 10000

2-part gap filler with high thermal conductivity for electronics components



Benefits

- High thermal conductivity range of 10 W/m-K
- Provides excellent thermal performance with a high dispense rate for easy, robust processing.
- Good gap stability under harsh conditions
- Good wetting to substrate even after long-term using
- Excellent reliability
- Flame retardance (UL94 V0)



Sustainability Value

- Reduced D4 to D10 content ensures compliance and minimizes outgassing.
- Faster dispensing property increases throughput and saves energy.

Leverage Henkel's broad technology portfolio and application know-how to strengthen your automotive electronics applications.



Henkel Adhesive Technologies









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2-part gap filler with high thermal conductivity for electronics components

Product Properties

Silicone Pale Red 10 12
10
``
12
10 ¹²
80
Fully cured in 7 days
6 months

Typical Applications

- Automotive Car Computer, Domain Control & Zone Control
- Power Conversion Systems
- Telecom
- Consumer Electronics





Available Configurations

- 600 CC (Part A & B Semco Cartridge)
- 1200CC (Part A & B Semco Cartridge)

CONTACT US TO LEARN MORE

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